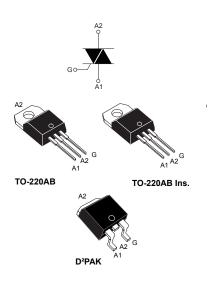


T1635H-6I, T1635H-6T, T1635H-6G T1650H-6I, T1650H-6T, T1650H-6G

Datasheet

16 A - 600 V H-series Snubberless Triac



Features

- Medium current Triac
- 150 °C max. T_i turn-off commutation
- Low thermal resistance with clip bonding
- Very high 3 quadrant commutation capabilities
- Packages are RoHS (2002/95/EC) compliant
- UL certified (ref. file E81734)

Application

The 600 V T1635H and T1650H are especially designed to operate in high power density or universal motor applications such as vacuum cleaner, coffee brewers, and inrush current limiter for inverter based home appliances.

Description

Available in through-hole or surface mount packages, these Triac series are suitable for general purpose mains power ac switching.

These 20 A Triacs provide a very high switching capability up to junction temperatures of 150 °C.

The heatsink can be reduced, compared to traditional Triacs, according to the high performance at given junction temperatures.

By using an internal ceramic pad, the TO-220AB insulated version provide voltage insulation (rated at 2500 V_{RMS}).

The surface mount D²PAK package enables compact SMD based designs for automated manufacturing.

Product status link
T1635H-6I, T1635H-6T, T1635H-6G, T1650H-6I, T1650H-6T, T1650H-6G

Product summary				
I _{T(RMS)}	16 A			
V _{DRM} /V _{RRM}	600 V			
I _{GT}	35 or 50 mA			



1 Characteristics

Symbol	Parameter	Value	Unit		
I _{T(RMS)}	RMS on-state current (full sine wave)	D ² PAK, TO-220AB	T _c = 130 °C	16	A
		TO-220AB Ins.	T _c = 113 °C	·	
ITOM	Non repetitive surge peak on-state current (full cycle,	f = 50 Hz	t = 20 ms	160	Α
ITSM	T _j initial = 25 °C)	f = 60 Hz	t = 16.7 ms	168	
l ² t	I ² t value for fusing	t _p = 10 ms	169	A ² s	
dl/dt	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$, tr ≤ 100 ns, f = 100 Hz	f = 120 Hz	T _j = 150 °C	100	A/µs
V _{DSM} / V _{RSM}	Non Repetitive peak off-state voltage	t _p = 10 ms	T _j = 25 °C	V _{DRM} /V _{RRM} +100	V
I _{GM}	Peak gate current	T _j = 150 °C	4	А	
P _{G(AV)}	Average gate power dissipation	1	W		
T _{stg}	Storage temperature range	-40 to +150	°C		
Tj	Operating junction temperature range	-40 to +150	°C		

Table 1. Absolute maximum ratings (limiting values)

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified)

Symbol	Test conditions	Quadrants		Value		Unit
Symbol		Quadrants		T1635H	T1650H	
I _{GT} ⁽¹⁾	V _D = 12 V, R _L = 33 Ω	- -	Max.	35	50	mA
V _{GT}	VD - 12 V, NL - 33 22	1 - 11 - 111	Max.	1.0		V
V _{GD}	$V_{D} = V_{DRM}, R_{L} = 3.3 \text{ k}\Omega \qquad \qquad I - II$		Min.	0.15		V
ΙL	$I_{G} = 1.2 \times I_{GT}$	1 - 111	Max.	50	90	mA
ч <u>с</u>	IG = 1.2 × IG	II	Max.	80	110	111/4
I _H ⁽²⁾	I _T = 500 mA, gate open		Max.	35	75	mA
dV/dt (2)	V_D = 2/3 x V_{DRM} , gate open	T _j = 150 °C	Min.	1000	1500	V/µs
(dl/dt)c (2)	Without snubber	T _j = 150 °C	Min.	21	28	A/ms

1. Minimum I_{GT} is guaranteed at 20% of I_{GT} max.

2. For both polarities of A2 referenced to A1.

Table 3. Static characteristics

Symbol	Test conditions		Value	Unit	
V _T ⁽¹⁾	I _{TM} = 23 A, t _p = 380 μs	T _j = 25 °C	Max.	1.5	V
V _{TO} ⁽¹⁾	Threshold voltage	T _j = 150 °C	Max.	0.80	V
R _D (1)	Dynamic resistance	T _j = 150 °C	Max.	23	mΩ
	V – V	T _j = 25 °C	Max.	5	μA
I _{DRM} /	V _{DRM} = V _{RRM}	T _j = 150°C		4.1	mA
I _{RRM} ⁽²⁾	$V_D = V_R = 400 V$, peak voltage	T _j = 150 °C	Max.	3.5	mA
	$V_D = V_R = 200 V$, peak voltage	T _j = 150 °C	Max.	3.0	ШA

1. For both polarities of A2 referenced to A1.

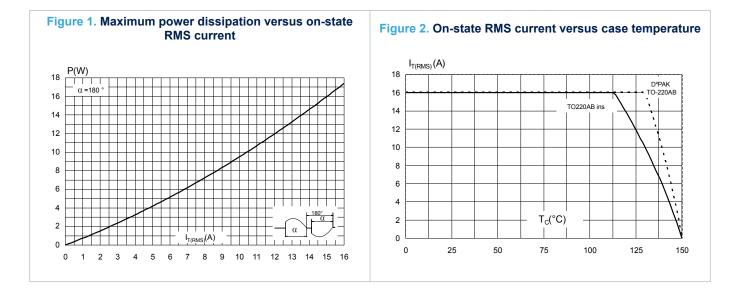
2. t_p = 380 µs

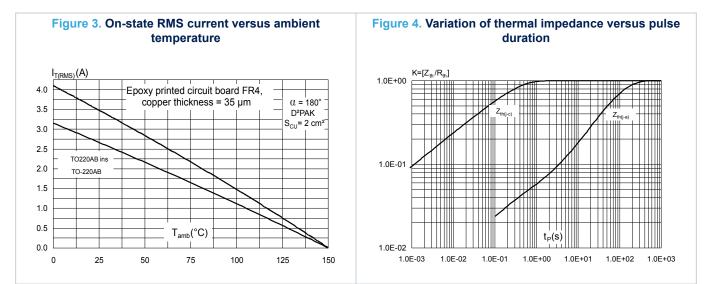
Table 4. Thermal resistance

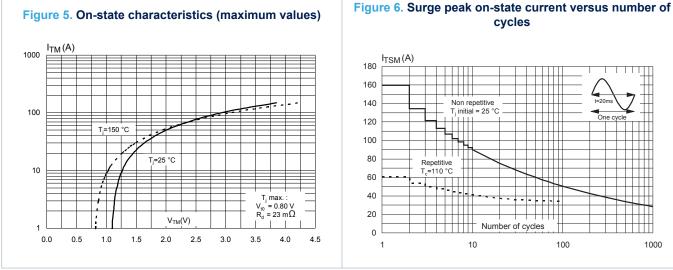
Symbol	Parameter					
R _{th(j-c)}	Junction to case (AC)	D ² PAK, TO-220AB	1.15	°C/W		
		TO-220AB Ins.	2.1			
R _{th(j-a)}	Junction to ambient ($S_{cu} = 2 \text{ cm}^2$)	D ² PAK, TO-220AB	45	°C/W		
	Junction to ambient	TO-220AB Ins.	60			

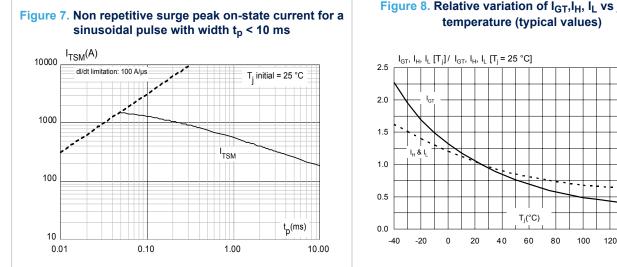


1.1 Characteristics (curves)











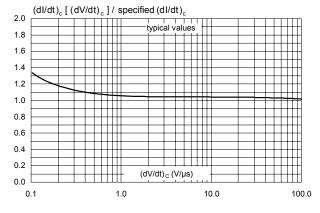


Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature

.

160 140

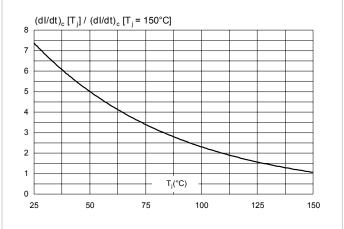
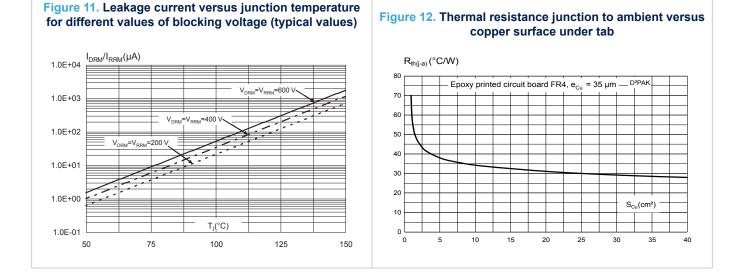




Figure 8. Relative variation of I_{GT},I_H, I_L vs junction







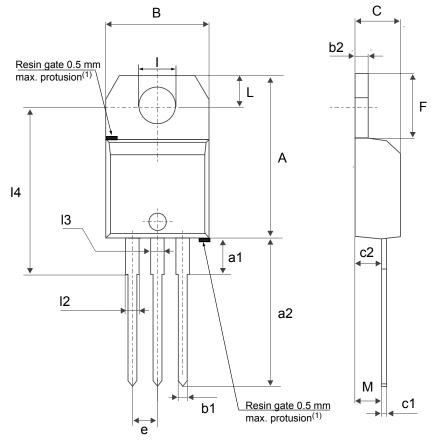
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 TO-220AB package information

- Molding compound resin is halogen-free and meets flammability standard UL94 level 0
- Lead-free package leads finishing
- ECOPACK2 compliant
- Recommended torque: 0.4 to 0.6 N.m

Figure 13. TO-220AB package outline



(1)Resin gate position accepted in one of the two positions or in the symmetrical opposites.

	Dimensions					
Ref.		Millimeters		Inches ⁽¹⁾		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	15.20		15.90	0.5984		0.6260
a1		3.75			0.1476	
a2	13.00		14.00	0.5118		0.5512
В	10.00		10.40	0.3937		0.4094
b1	0.61		0.88	0.0240		0.0346
b2	1.23		1.32	0.0484		0.0520
С	4.40		4.60	0.1732		0.1811
c1	0.49		0.70	0.0193		0.0276
c2	2.40		2.72	0.0945		0.1071
е	2.40		2.70	0.0945		0.1063
F	6.20		6.60	0.2441		0.2598
I	3.73		3.88	0.1469		0.1528
L	2.65		2.95	0.1043		0.1161
12	1.14		1.70	0.0449		0.0669
13	1.14		1.70	0.0449		0.0669
14	15.80	16.40	16.80	0.6220	0.6457	0.6614
Μ		2.6			0.1024	

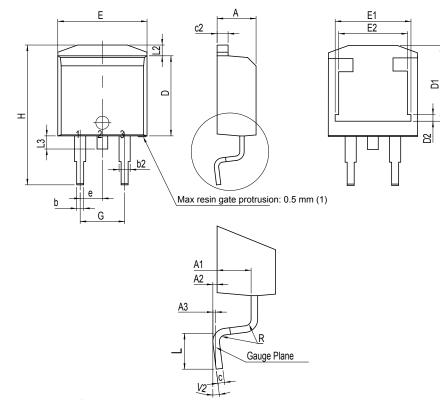
Table 5. TO-220AB package mechanical data

1. Inch dimensions are for reference only.



2.2 D²PAK package information

Figure 14. D²PAK package outline



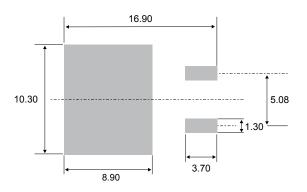
(1) Resin gate is accepted in each of position shown on the drawing, or their symmetrical.

	Dimensions					
Ref.		Millimeters			Inches ⁽¹⁾	
	Min.	Тур.	Max.	Min.	Тур.	Max.
A	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
A3		0.25			0.0098	
b	0.70		0.93	0.0276		0.0366
b2	1.25		1.7	0.0492		0.0669
с	0.45		0.60	0.0177		0.0236
c2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
е	2.54			0.1		
E	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
Н	15		15.85	0.5906		0.6240
L	1.78		2.28	0.0701		0.0898
L2	1.27		1.40	0.0500		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2	0°		8°	0°		8°

Table 6. D²PAK package mechanical data

1. Dimensions in inches are given for reference only

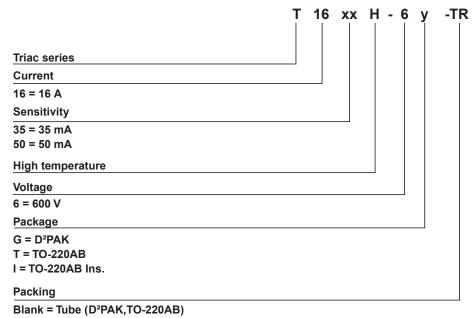






3 Ordering information

Figure 16. Ordering information scheme



-TR = Tape and reel (D²PAK)

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T16xxH-6G	T16xxH 6G	D²PAK	2041/ 1.5.4		Tube
T16xxH-6G-TR	110000 00	DPAK	1.5 g	1000	Tape and reel 13"
T16xxH-6T	T16xxH 6T	TO-220AB	2.3 g	50	Tube
T16xxH-6I	T16xxH 6I	TO-220AB Ins.	2.3 g	50	Tube



Revision history

Date	Version	Changes
29-May-2007	1	First issue.
20-Sep-2011	2	Updated: Features, Description and Figure 2.
31-Jan-2014	3	Updated Figure 2, Figure 3, Figure 4, Table 2 and Table 5.
23-Mar-2020	4	Updated Table 1. Absolute maximum ratings (limiting values) and Figure 3. On-state RMS current versus ambient temperature.



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